

1. Scope

Fundamental requirement for an escrow deposit is that a qualified person should be able to continue maintenance of the material for continuity purposes. This implies that an escrow deposit should contain:

- A complete environment (all sources), not only the final results of the development process
- Background information on the environment – the Industrial Deposit Specification Form (IDSF).

As the IDSF must be included with each escrow deposit we advise you to download the digital version (www.escroweurope.com/download).

If you have any questions, please contact us at: technical@escroweurope.com or tel: +31 20 6207151.

2. General Information

Supported media

Please note that we only accept data stored on CDROM or DVD. If this is not possible, please contact us.

Compression

We strongly advice suppliers to store all material uncompressed as it cannot be guaranteed that used compression software will be commercially available in the future. If compression is to be used please use one the following: Zip/Tar/Rar.

Encryption

In case you require the data to be encrypted before shipment or electronic transfer, please contact us.

Online deposit

Please visit www.depositcentral.com for more information.

Shipment

Please ship the material to: Escrow Europe
Attn. Technical Department
Herengracht 414, NL-1017 BZ Amsterdam
The Netherlands

3. Important Information

1. By signing an escrow contract, supplier warrants that an escrow deposit is complete: therefore always check whether all material parties have agreed upon in the escrow contract is provided.
2. Adhere to supported media. Escrow Europe will return any media which are not supported or which contain data archived/compressed by unsupported archiving/compression programs.
3. Any hardware and/or software entry codes and passwords must be provided.
4. Please note that this is an all-purpose document; not each item might be applicable in your case.
5. Please use a separate IDSF for each product.

INDUSTRIAL DEPOSIT SPECIFICATION FORM

GENERAL

1. Supplier Information

Company Name: _____
Technical Contact: _____
E-mail: _____
Telephone: _____

2. Product Information

Product name as known in the escrow contract/ to the escrow beneficiary.

Product Name: _____
Version: _____
Escrow Beneficiaries: _____

3. Product Details – Modules

Should the product consist of multiple “modules”; please list these and any revision numbers here.

Hardware: _____

Programmable Logic Devices: _____

Firmware: _____

Software: _____

4. Media Information

Please list all media provided (CD/DVD).

Medium	Quantity	Label
_____	_____	_____
_____	_____	_____
_____	_____	_____

INDUSTRIAL DEPOSIT SPECIFICATION FORM

HARDWARE

1. Development Environment

Computer Type: _____

Operating System: _____

Development Tools: _____

2. Schematic and PCB Layout

If no modules – only list product name.

Module Name	Path\directory where material is located
_____	_____
_____	_____
_____	_____

3. Manufacturing & Assembly Documentation

Module Name	Path\directory where material is located
_____	_____
_____	_____
_____	_____

4. Gerber Files

Module Name	Path\directory where material is located
_____	_____
_____	_____
_____	_____

5. Bill Of Materials

Module Name	Path\directory where material is located
_____	_____
_____	_____
_____	_____

6. Other Documentation

For example hardware user documentation; mechanical or configuration options or test plan.

INDUSTRIAL DEPOSIT SPECIFICATION FORM

PROGRAMMABLE LOGIC DEVICES

1. Development Environment

Computer Type: _____

Operating System: _____

Development Tools: _____

Third party libraries/components: _____

2. Runtime Environment

PLD required to run code: _____

3. PLD Source Code

If no modules – only list product name.

Module Name	Path\directory where material is located
_____	_____
_____	_____
_____	_____

4. Technical Documentation

Please list location of technical documentation.

5. User Documentation

Please list location of user documentation.

INDUSTRIAL DEPOSIT SPECIFICATION FORM

FIRMWARE/EMBEDDED SOFTWARE

1. Development Environment

Computer Type: _____

Operating System: _____

Development Tools: _____

Third party libraries/components: _____

2. Runtime Environment

Microcontroller required to run code: _____

3. Firmware/Embedded Source Code

If no modules – only list product name.

Module Name	Path\directory where material is located
_____	_____
_____	_____
_____	_____

4. Technical Documentation

Please list location of technical documentation.

5. User Documentation

Please list location of user documentation.

INDUSTRIAL DEPOSIT SPECIFICATION FORM

SOFTWARE

1. Development Environment

Computer Type: _____

Operating System: _____

Development Tools: _____

Third party libraries/components: _____

2. Runtime Environment

Computer Type: _____

Operating System: _____

Software: _____

3. Source Code

If no modules – only list product name.

Module Name	Path\directory where material is located
_____	_____
_____	_____
_____	_____

4. Technical Documentation

Please list location of technical documentation.

5. User Documentation

Please list location of user documentation.
